Datasheet

MBX2000

EBX Form Factor Motherboard



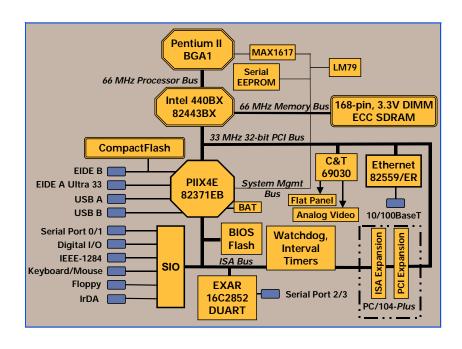


Low power consumption and reduced heat dissipation combined in a small form factor EBX motherboard

Motorola's MBX2000 embedded controller provides a solution to customers who require low power consumption and reduced heat generation in a small form factor board. This EBX form factor board provides a wide array of standard features including a 266/333 MHz Intel Pentium II processor—Low Power supporting 66 MHz front-side bus frequency, 440BX AGPset, 10/100Mbit Ethernet, USB, IDE CompactFlash, graphics, watchdog and countdown timers, PCI/ISA support, Phoenix BIOS, and many other features.

This EBX open architecture motherboard with value-added features, such as an on-board LCD interface, is ideal for embedded industrial automation, laboratory/scientific, medical, diagnostic, and communications applications. EBX also targets embedded applications such as vending machines, medical diagnostic touch screens, communications equipment, and information kiosks.

- 266/333 MHz BGA1 Intel Pentium II processor—Low Power
- Intel 440BX AGPset with support for 66 MHz processor-side bus
- 256KB L2 cache
- One DIMM slot supporting 3.3 V PC100 compatible SDRAM memory
- 10/100Mbit Ethernet interface
- Optional accelerated 2D graphics with 4MB video memory; available with VGA and flat panel connectors
- Four RS-232 serial ports (two RS-232, two RS-232/422/485), parallel, floppy, PS/2 keyboard/mouse support, two USB ports, IrDA header, and 16 digital I/O channels
- PC/104 and PC/104-Plus expandability (ISA and PCI support)
- Watchdog timer, interval timers, and hardware monitor
- ATA/33 EIDE interface with CompactFlash Type II socket on one EIDE channel
- Supports Windows[®] NT, Linux, and VxWorks operating systems



MBX2000 DETAILS

Intel Pentium II Processor-Low-Power

For embedded applications, the MBX2000 fully supports the Pentium II processor—Low Power. The processor is combined with the Intel 440BX PCI chipset resulting in exceptional processing capability. The low-power processor contains 32KB of internal Level 1 cache memory as well as 256KB of Level 2 cache delivering rapid data access to complex applications. Dynamic execution and dual independent buses are additional performance advantages. For continual processor speed enhancement options, consult your Motorola sales representative.

Memory

The MBX2000 provides one 168-pin DIMM site for onboard memory expansion. 256MB of PC100 compliant synchronous DRAM is supported.

Super I/O Functions

The National PC97317 provides a highly integrated set of functions: two asynchronous serial ports, two RS-234/422/485 ports, digital I/O, IEEE 1284 host parallel port, floppy port, keyboard and mouse ports, and IrDA port.

2D Accelerated Graphics

An optional CHIPS 69030 HiQVideo accelerator with 4MB integrated memory provides eye-opening 2D accelerated graphics performance for human-machine interfaces and imaging applications. Single view up to 1280 x 1024. VGA and flat-panel interfaces are provided.

SPECIFICATIONS

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Single 266/333 MHz Intel Pentium II processor-Low Power

Cache

Level 1: 16/16KB instruction/data **Level 2:** 256KB L2 (integrated)

Memory

Type: SDRAM with optional ECC (PC100

compliant)

Capacity: Up to 256MB

Ultra DMA/33 EIDE Interface

Controller: 82371EB PCI-to-ISA/IDE Xcelerator

(PIIX4E)

Connections: Two; one connected to hard disk drive port

and one connected to Type II
CompactFlash port and hard disk drive

port

Super I/O

Controller: National Semiconductor PC97317

Interfaces: Two RS-232 serial ports, parallel port,

PS/2 floppy port, PS/2 keyboard/mouse interfaces and an IrDA port

Bus Interfaces

PCI Bus: 32-bit PCI bus, up to 33 MHz is supported ISA Bus: 16-bit ISA bus, up to 8/33 MHz supported

PCI Bus

Controller: 82443BX
Signaling: 5 V
Connector: PC/104-Plus

ISA Bus

IDE Flash

Type: Type II CompactFlash **Capacity:** 2–192MB

Ethernet

Controller: Intel 82559ER
Interface speed: 10/100Mb/s
Local Bus DMA: Yes
Connector: RJ-45

Graphics

Controller: CHIPS 69030 2D accelerated video

Video Memory: 4MB on-chip SDRAM Resolution: 1280 x 1024 max.

Supervisory

Watchdog Timer: Two-level, software programmable (100

msec. to 27 min.); drives interrupt, NMI,

SMI, system reset

LM79: Provides for temperature, fan speed, and

voltage monitoring; single on-board temperature sensor and limit register for local temperature monitoring and

interrupt generation

MAX1617: CPU temperature monitor

Reset switch: Push-button reset

Power Requirements

Exclusive of attached daughter boards and/or peripherals. Notes:

- 1. The MBX2000A uses +5 VDC for standard operation
- 2. +5 VDC requirement for CompactFlash
- 3. ±12 VDC and +5 VDC requirement for flat panel
- 4. ±12 VDC and -5 VDC requirement for PC/104, PC/104-Plus, other add-on components

266 MHz Board Configuration	+5 VDC Typical	Power
MBX2000A-101—no on-board graphics; 128MB SDRAM @ 66 MHz	2.8 Amp	14.0 W
MBX2000A-102— with on-board graphics; 64MB SDRAM @ 66 MHz	3.0 Amp	15.0 W
MBX2000A-102— with on-board graphics; 128MB SDRAM @ 66 MHz	3.0 Amp	15.0 W
MBX2000A-102— with on-board graphics; 256MB SDRAM @ 66 MHz	3.3 Amp	16.5 W
333 MHz Board Configuration	+5 VDC Typical	Power
	+5 VDC Typical 3.0 Amp	15.0 W
Configuration MBX2000A-103—no on-board graphics; 128MB SDRAM @ 66		
Configuration MBX2000A-103—no on-board graphics; 128MB SDRAM @ 66 MHz MBX2000A-104—with on-board graphics; 64MB	3.0 Amp	15.0 W

RTC and CMOS RAM

EPROM backup for CMOS RAM

USB

Dual independent USB channels for 1.5Mb/s and 12Mb/s transfer

Software Support

The MBX2000 is supported by a variety of operating systems, including a complete range of real-time operating systems and kernels.

Safety

All printed wiring boards (PWBs) are manufactured with a flammability rating of 94V-0 or better.

Board Size

EBX Form Factor: 203.2 mm (8.0 in.) x 146.1 mm (5.75 in.) Max. Component 19.1 mm (0.75 in.), without DIMM or

Height: PC/104 modules

Demonstrated MTBF

(based on a sample of eight boards in an accelerated stress environment)

> Mean: 190,509 hours 95% Confidence: 107,681 hours

Environmental

	Operating	Nonoperating
Temperature:	0° C to +55° C	−40° C to +70° C
Humidity (NC):	5% to 95%	5% to 95%
Vibration:	1 G Sine Sweep 5–100 Hz	0.5 G Sine Sweep 5–50 Hz; 3 G Sine Sweep 50–500 Hz;

Electromagnetic Compatibility (EMC)

Intended for use in systems meeting the following regulations:

U.S.: FCC Part 15, Subpart B, Class A or B

Canada: ICES-003, Class A or B

This product was tested in a representative system to the following standards:

CE Mark per European EMC Directive 89/336/EEC with Amendments; Emissions: EN55022 Class B; Immunity: EN55024

ORDERING INFORMATION

Part Number	Description		
MBX2000-101A	266 MHz Pentium II processor, no on-board graphics		
MBX2000-102A	266 MHz Pentium II processor, on-board graphics		
MBX2000-103A	333 MHz Pentium II processor, no on-board graphics		
MBX2000-104A	333 MHz Pentium II processor, on-board graphics		
Memory Modules (1DIMM limit per order)			
MEMSDRM256-F	256MB, PC100, ECC, SDRAM		
MEMSDRM256-K	256MB, PC100, ECC, SDRAM		
Related Products			
MBX2000DEVKIT	MBX2000 Development Kit: Mounting plate, Cable kit, which contains the following: • ATX to EBX power cable • Keyboard/mouse/reset cable • Parallel port transition cable • Serial port transition cable (dual port) • USB transition cable (dual port) • VGA transition cable • IDE ribbon cable (2mm, 44-position socket)		
Documentation			
MBX2000AA/IH	MBX2000 Installation and Use Manual		
MBX2000A/PG	MBX2000 Programmer's Guide		
Documentation is available for online viewing and ordering at http://www.motorola.com/computer/literature			

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